

# Specification for Approval

Date: 2023/08/29

**Customer :** \_\_\_\_\_

**TAI-TECH P/N:** WCM3216F2SV-601T03-HD

**CUSTOMER P/N:** \_\_\_\_\_

**DESCRIPTION:** \_\_\_\_\_

**QUANTITY:** \_\_\_\_\_ pcs

<b>REMARK:</b>		
Customer Approval Feedback		

**西北臺慶科技股份有限公司**  
**TAI-TECH Advanced Electronics Co., Ltd**

- 西北臺慶科技股份有限公司  
 TAI-TECH Advanced Electronics Co., Ltd  
 Headquarter:  
 NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI,  
 TAO-YUAN HSIEN, TAIWAN, R.O.C.  
 TEL: +886-3-4641148 FAX: +886-3-4643565  
 http://www.tai-tech.com.tw  
 E-mail: sales@tai-tech.com.tw

- Office:  
 深圳辦公室  
 11BC, Building B Fortune Plaza, NO.7002, Shennan Avenue, Futian  
 District Shenzhen  
 TEL: +86-755-23972371 FAX: +86-755-23972340

- 臺慶精密電子(昆山)有限公司  
 TAI-TECH ADVANCED ELECTRONICS(KUNSHAN) CO., LTD  
 SHINWHA ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN,  
 JIANG-SU, CHINA  
 TEL: +86-512-57619396 FAX: +86-512-57619688  
 E-mail: sales@tai-tech.cn

- 慶邦電子元器件(泗洪)有限公司  
 TAIPAQ ELECTRONICS (SIHONG) CO., LTD  
 Sihong development zone Suqian City, Jiangsu, CHINA.  
 TEL: +86-527-88601191 FAX: +86-527-88601190  
 E-mail: sales@taipaq.cn

Sales Dep.

APPROVED	CHECKED
管哲頌 Eric Kuan	林巧盈 Emily Lin

R&D Center

APPROVED	CHECKED	DRAWN
楊祥忠 Mike Yang	林志鴻 Zhi-Hong Lin	林靜婷 Michelle Lim

**Wire Wound Type Common Mode Filter**

WCM3216F2SV-601T03-HD

**ECN HISTORY LIST**

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	23/08/29	新發行	楊祥忠	林志鴻	林靜婷
備 註					

# Wire Wound Type Common Mode Filter

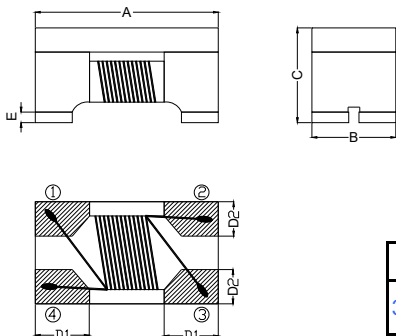
WCM3216F2SV-601T03-HD

## 1. Features

1. High common mode impedance at high frequency cause excellent noise suppression performance.
2. WCM3216F2SV series realizes small size and low profile. 3.2x1.6x2.0 mm.
3. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
4. High reliability -Reliability tests comply with AEC-Q200
5. Operating temperature-55~+125°C (Including self - temperature rise)



## 2. Dimension



Series	A(mm)	B(mm)	C(mm)	D1(mm)	D2(mm)	E(mm)
3216F2SV	3.2±0.2	1.6±0.2	2.0±0.2	0.5±0.1	0.5±0.1	0.15±0.1

Units: mm

## 3. Part Numbering

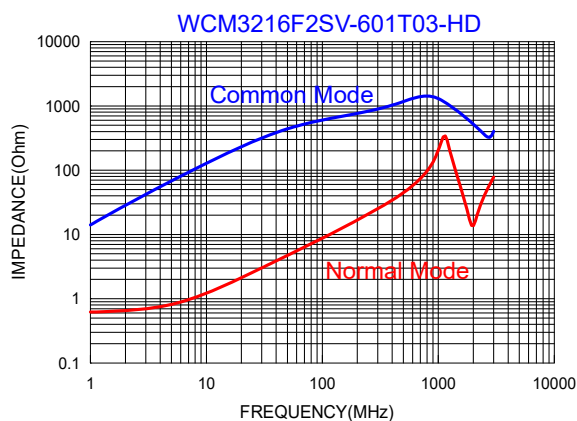


- A: Series
- B: Dimension
- C: Material                      Ferrite Core
- D: Number of Lines            2=2 lines
- E: Type                            S=Shielded , N=Unshielded
- F: Category Code                V=Vehicle
- G: Impedance                    601=600Ω
- H: Packaging                      T=Taping and Reel
- I : Rated Current                03=300mA
- J: Control S/N

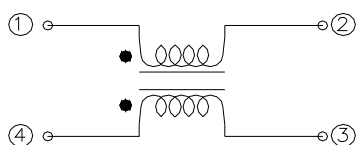
## 4. Specification

TAI-TECH Part Number	Common mode Impedance (Ω)	Test Frequency (MHz)	DC Resistance (Ω) max.	Rated Current (mA)max.	Rated Volt. (Vdc)max.	Withstand Volt. (Vdc) Max.	IR (Ω) min.
WCM3216F2SV-601T03-HD	600±25%	100	0.80	300	50	125	10M

### Typical Impedance v.s. Frequency Curve

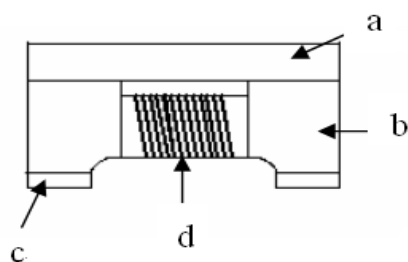


### 5. Schematic Diagram



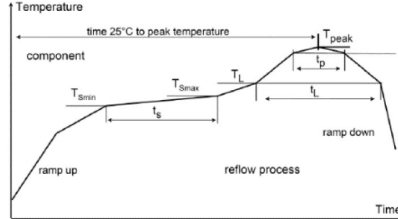
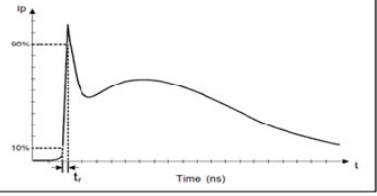
### 6. Materials

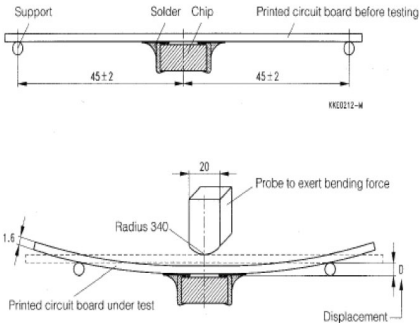
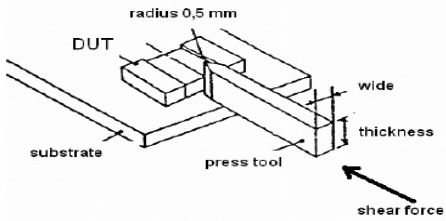
No.	Description	Specification
a.	Upper Plate	Ferrite
b.	Core	Ferrite Core
c.	Termination	Ag/Ni/Sn
d.	Wire	Enameled Copper Wire



### 7. Reliability and Test Condition

Item	Performance	Test Condition															
Operating temperature	-55~+125°C (Including self - temperature rise)																
Storage temperature	-55~+125°C (on board)																
<b>Electrical Performance Test</b>																	
Z(common mode)	Refer to standard electrical characteristics list.	Keysight E4991B + Keysight 16197A															
DCR		Agilent-34420A Agilent-4338B															
I.R.		Chroma 19073															
Temperature Rise Test	Rated Current ΔT 40°C Max	1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer															
<b>Reliability Test</b>																	
High Temperature Exposure(Storage) AEC-Q200		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : 125±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±4 hrs.															
Temperature Cycling AEC-Q200		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -55±2°C 30min Min. Step2 : 125±2°C transition time 1min MAX. Step3 : 125±2°C 30min Min. Step4 : Low temp. Transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±4 hrs.															
Moisture Resistance (AEC-Q200)	Appearance : No damage. Impedance : within±15% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	t=24 hours/cycle. Note: Steps 7a & 7b not required. Unpowered. Measurement at 24±2 hours after test conclusion. 															
Biased Humidity (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles) Humidity : 85±3% R.H, Temperature : 85°C±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±4hrs.															
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles) Temperature : 125±2°C Duration : 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24±4hrs.															
External Visual	Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.															
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement															
Resistance to Solvents		Add aqueous wash chemical - OKEM clean or equivalent.															
Mechanical Shock	Appearance : No damage. Impedance : within±15% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (Vi)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> <tr> <td>Lead</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> </tbody> </table> <p>3 shocks in each direction along 3 perpendicular axes. (18 shocks).</p>	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec	SMD	100	6	Half-sine	12.3	Lead	100	6	Half-sine	12.3
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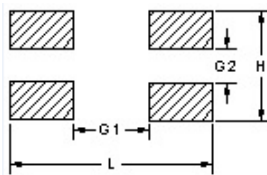
Item	Performance	Test Condition																																																				
Vibration		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles) Oscillation Frequency : 10Hz~2kHz~10Hz for 20 minutes Equipment : Vibration checker Total Amplitude : 5g Testing Time : 12 hours (20 minutes, 12 cycles each of 3 orientations)																																																				
Resistance to Soldering Heat	Appearance : No damage. Impedance : within±15% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	Test condition : <table border="1" data-bbox="906 383 1406 479"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table> Depth: completely cover the termination Continental  <table border="1" data-bbox="906 779 1374 958"> <thead> <tr> <th>Component Size</th> <th>Ramp up to 150°C</th> <th>T<sub>min</sub></th> <th>t<sub>1</sub></th> <th>T<sub>soak</sub></th> <th>T<sub>1</sub></th> <th>t<sub>2</sub></th> <th>T<sub>peak</sub>*</th> <th>t<sub>3</sub>**</th> <th>time 25°C to peak</th> <th>Ramp down</th> </tr> </thead> <tbody> <tr> <td>Thickness &lt; 1.5mm or Thickness 1.5mm-2.5mm and Volume &lt; 350 mm<sup>3</sup></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥250°C</td> <td>≥40s</td> <td></td> <td></td> </tr> <tr> <td>Thickness 1.5mm-2.5mm and Volume 350-2000 mm<sup>3</sup> or Thickness &gt; 2.5mm and Volume &lt; 350 mm<sup>3</sup></td> <td>3.0±0.1°C/s (The component shall be specified for usage in serial production with up to 3.0°C/s)</td> <td>≥150°C</td> <td>≥110s</td> <td>≥200°C</td> <td>≥217°C</td> <td>≥90s</td> <td>≥250°C</td> <td>≥30s</td> <td></td> <td>6.0±0.1°C/s (The component shall be specified for usage in serial production with up to 6.0°C/s)</td> </tr> <tr> <td>Thickness 1.5mm-2.5mm and Volume &gt; 2000 mm<sup>3</sup> or Thickness &gt; 2.5mm and Volume &gt; 350 mm<sup>3</sup></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥245°C</td> <td></td> <td></td> <td></td> </tr> </tbody> </table> Table 1: Minimum requirements for lead-free soldering *peak temperature is measured on the centre top of the component package ** tp measured @ T <sub>peak</sub> -5°C	Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles	260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1	Component Size	Ramp up to 150°C	T <sub>min</sub>	t <sub>1</sub>	T <sub>soak</sub>	T <sub>1</sub>	t <sub>2</sub>	T <sub>peak</sub> *	t <sub>3</sub> **	time 25°C to peak	Ramp down	Thickness < 1.5mm or Thickness 1.5mm-2.5mm and Volume < 350 mm <sup>3</sup>							≥250°C	≥40s			Thickness 1.5mm-2.5mm and Volume 350-2000 mm <sup>3</sup> or Thickness > 2.5mm and Volume < 350 mm <sup>3</sup>	3.0±0.1°C/s (The component shall be specified for usage in serial production with up to 3.0°C/s)	≥150°C	≥110s	≥200°C	≥217°C	≥90s	≥250°C	≥30s		6.0±0.1°C/s (The component shall be specified for usage in serial production with up to 6.0°C/s)	Thickness 1.5mm-2.5mm and Volume > 2000 mm <sup>3</sup> or Thickness > 2.5mm and Volume > 350 mm <sup>3</sup>							≥245°C			
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Thermal shock (AEC-Q200)		Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles) Condition for 1 cycle Step1 : -55±2°C 15±1min Step2 : 125±2°C within 20Sec. Step3 : 125±2°C 15±1min Number of cycles : 300 Measured at room temperature after placing for 24±4hrs.																																																				
ESD	Appearance : No damage. Impedance : within±15% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	 Direct Contact and Air Discharge PASSIVE COMPONENT HBM ESD Discharge Waveform to a Coaxial Target Test method : AEC-Q200-002 Test mode : Contact Discharge Discharge level : 4 KV (Level: 2 )																																																				
Solderability	More than 95% of the terminal electrode should be covered with solder	a. Method B, 4hrs @155°C dry heat @235°C±5°C Testing Time : 5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time : 30 +0/-0.5 seconds																																																				
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.																																																				
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.																																																				

Item	Performance	Test Condition
<p>Board Flex</p>	<p>Appearance : No damage.                      Impedance : within±15% of initial value                      RDC : within ±15% of initial value and shall not exceed the specification value</p>	<p>Preconditioning: Run through reflow for 3 times.( IPC/JEDEC J-STD-020E Classification Reflow Profiles)                      Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.</p> 
<p>Terminal Strength(SMD)</p>	<p>Appearance : No damage.                      Impedance : within±15% of initial value                      RDC : within ±15% of initial value and shall not exceed the specification value</p>	<p>AEC-Q200,TAI-TECH SPEC 10N / 30 SECONDS</p> 

## 8. Soldering and Mounting

### 8-1. Recommended PC Board Pattern

	<b>WCM3216F2S</b>
L(mm)	3.70
H(mm)	1.60
G1(mm)	1.90
G2(mm)	0.40



### 8-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### 8-2.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

#### 8-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.

Fig.1 Soldering Reflow

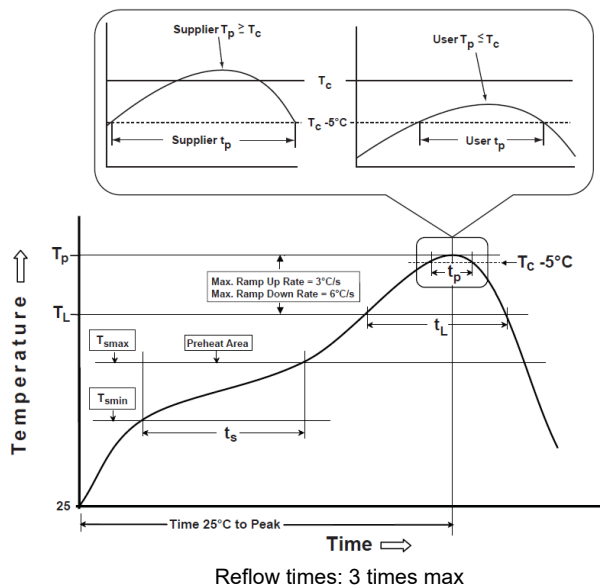
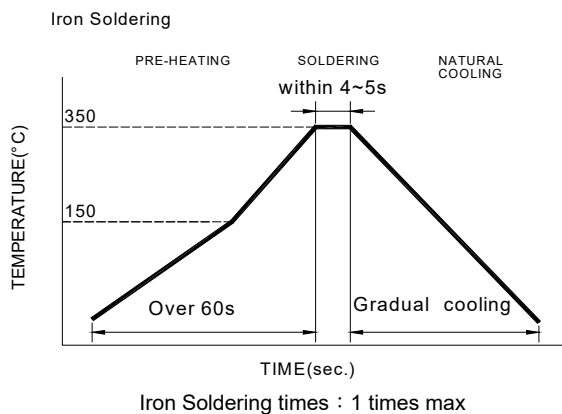


Fig.2 Iron soldering temperature profiles





**Table (1.1): Reflow Profiles**

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min( $T_{smin}$ ) -Temperature Max( $T_{smax}$ ) -Time( $t_s$ )from( $T_{smin}$ to $T_{smax}$ )	150°C 200°C 60-120seconds
Ramp-up rate( $T_L$ to $T_p$ )	3°C/second max.
Liquidus temperature( $T_L$ ) Time( $t_L$ )maintained above $T_L$	217°C 60-150 seconds
Classification temperature( $T_c$ )	See Table (1.2)
Time( $t_p$ ) at $T_c - 5^\circ\text{C}$ ( $T_p$ should be equal to or less than $T_c$ .)	< 30 seconds
Ramp-down rate( $T_p$ to $T_L$ )	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

**T<sub>p</sub>**: maximum peak package body temperature, **T<sub>c</sub>**: the classification temperature.

For user (customer) **T<sub>p</sub>** should be equal to or less than **T<sub>c</sub>**.

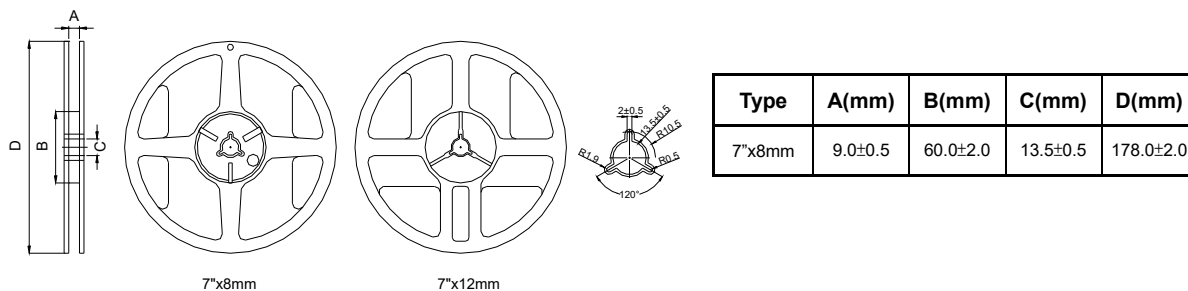
**Table (1.2) Package Thickness/Volume and Classification Temperature (T<sub>c</sub>)**

	Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

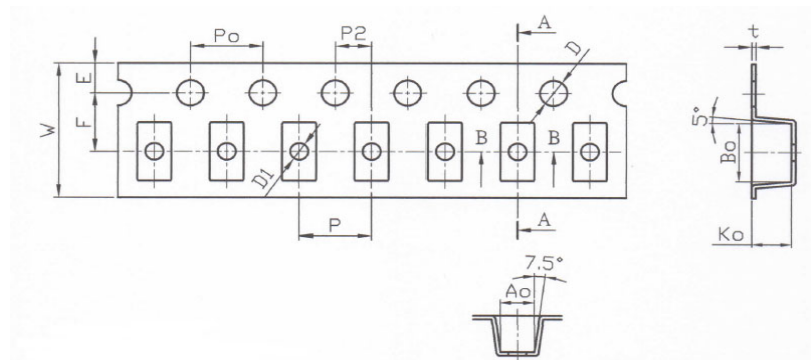
Reflow is referred to standard IPC/JEDEC J-STD-020E

## 9. Packaging Information

### 9-1. Reel Dimension



### 9-2. Tape Dimension / 8mm

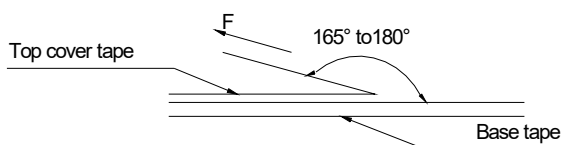


Series	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)	W(mm)	t(mm)	E(mm)	F(mm)	D(mm)	D1(mm)
WCM3216F2S	4.00±0.10	4.00±0.10	2.00±0.05	3.50±0.10	1.88±0.10	2.20±0.10	8.00±0.10	0.26±0.05	1.75±0.10	3.50±0.05	1.50+0.10/-0.00	1.0±0.10

### 9-3. Packaging Quantity

Chip size	Chip/Reel	Inner Box	Middle Box	Carton
WCM3216F2S	2000	10000	50000	100000

### 9-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

#### Application Notice

- Storage Conditions(component level)
  - To maintain the solderability of terminal electrodes:
    - TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
    - Temperature and humidity conditions: Less than 40°C and 60% RH.
    - Recommended products should be used within 12 months form the time of delivery.
    - The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
  - Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  - The use of tweezers or vacuum pick up is strongly recommended for individual components.
  - Bulk handling should ensure that abrasion and mechanical shock are minimized.



# 測試報告 Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 1 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)  
臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)  
慶邦電子元件(泗洪)有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)  
桃園市楊梅區幼獅工業區幼四路1號 (NO. 1, YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN CITY, TAIWAN R. O. C.)  
江蘇省昆山市蓬朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)  
中國·江蘇省·宿遷市·泗洪縣·經濟開發區杭州路南側·建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD·ECONOMIC DEVELOPMENT ZONE·SIHONG COUNTY·SUQIANCITY·JIANGSU PROVINCE·P,R·CHINA)


以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as) :

樣品名稱(Sample Name) : WIREWOUND SERIES  
樣品型號(Style/Item No.) : WCM(YCW) · WCL · HSF · HDMI · DVI · BCM · PCM · TCM · LCM · LPF · TXF · ACM · DCM(YLW) · WIH · BPH · TNH · YCM · STF · APO · QLL · FGO · APOC · TLAN SERIES

=====  
收件日(Sample Receiving Date) : 10-Mar-2023  
測試期間(Testing Period) : 10-Mar-2023 to 17-Mar-2023

測試需求(Test Requested) : 依據客戶要求進行測試·測試項目請參閱測試結果表格。(Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages.)

  
Troy Chang / Department Manager  
Signed for and on behalf of  
SGS TAIWAN LTD.  
Chemical Laboratory - Taipei



PIN CODE: 6621A826

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# 測試報告

## Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 2 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

慶邦電子元器件(泗洪)有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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中國·江蘇省·宿遷市·泗洪縣·經濟開發區杭州路南側·建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD·ECONOMIC DEVELOPMENT ZONE·SIHONG COUNTY·SUQIANCITY·JIANGSU PROVINCE·P,R·CHINA)

### 測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

### 測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鎘 (Cd) (Cadmium (Cd))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg))	參考IEC 62321-4: 2013+ AMD1: 2017 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI))	參考IEC 62321-7-2: 2017 · 以紫外光-可見光分光光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司

新北市五股區新北產業園區五權七路 25 號 t+886(02)2299 3939 f+886(02)2299 3237

25, Wu Chyuan 7th Road, New Taipei Industrial Park, Wu Ku District, New Taipei City, Taiwan

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯 (Monobromobiphenyl)	參考IEC 62321-6: 2015 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)		mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)		mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.

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江蘇省昆山市蓬朗區高橋工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP))	參考IEC 62321-8: 2017, 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-8: 2017, analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP))		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di-(2-ethylhexyl) phthalate (DEHP))		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP))		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40-0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12-0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n-pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
六溴環十二烷及所有主要被辨別出的異構物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	參考IEC 62321-9: 2021 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94-8)	參考BS EN 14582: 2016 · 以離子層析儀分析。(With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537-15-1)		mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097-32-2)		mg/kg	50	n.d.
碘 (I) (Iodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	參考CEN/TS 15968: 2010 · 以液相層析串聯質譜儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)		mg/kg	0.01	n.d.
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440-36-0)	參考US EPA 3052: 1996 · 以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	82.3
鈹 (Be) (Beryllium (Be)) (CAS No.: 7440-41-7)		mg/kg	2	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
聚氯乙烯 (Polyvinyl chloride) (PVC)	參考ASTM E1252: 2021 · 以傅立葉轉換紅外線光譜儀及焰色法分析。(With reference to ASTM E1252: 2021, analysis was performed by FT-IR and Flame Test.)	**	-	Negative

### 備註(Note) :

1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n.d. = Not Detected (未檢出) ; 小於MDL / Less than MDL
4. "-" = Not Regulated (無規格值)
5. \*\* = Qualitative analysis (No Unit) 定性分析(無單位)
6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
7. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including) :  
CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
8. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including) :  
CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
9. 樣品的測試是基於申請人要求混合測試 · 報告中的混合測試結果不代表其中個別單一材質的含量。  
The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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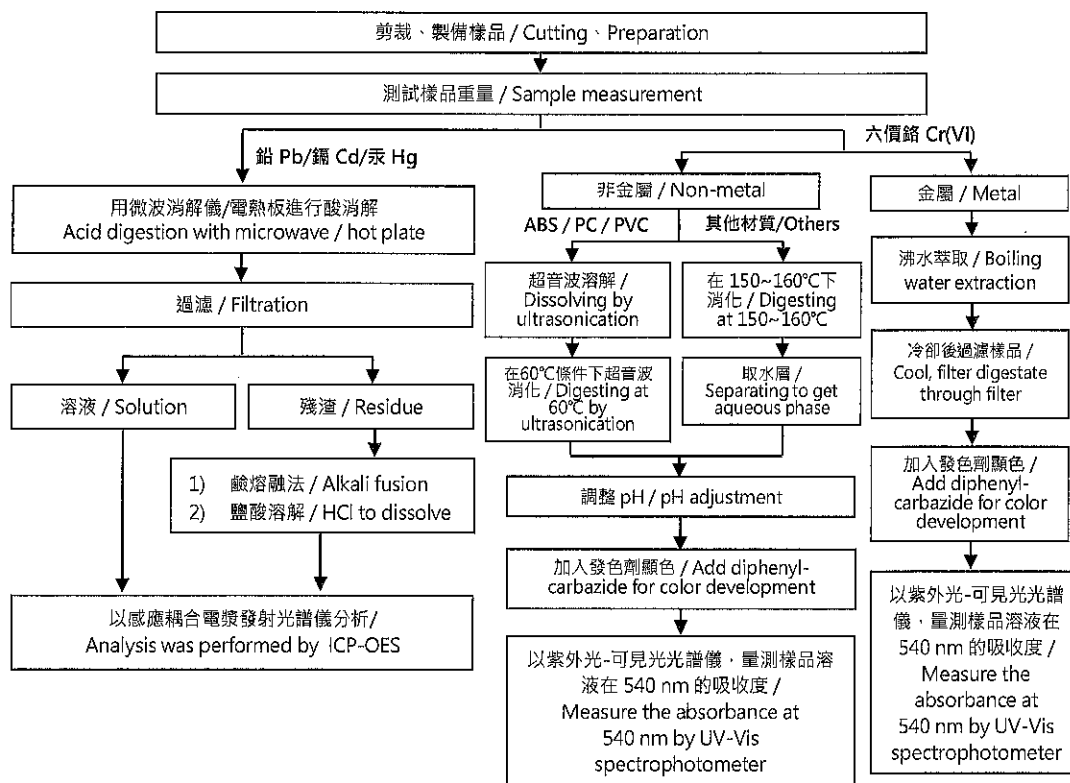
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### 重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件·樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.

(Cr<sup>6+</sup> test method excluded)



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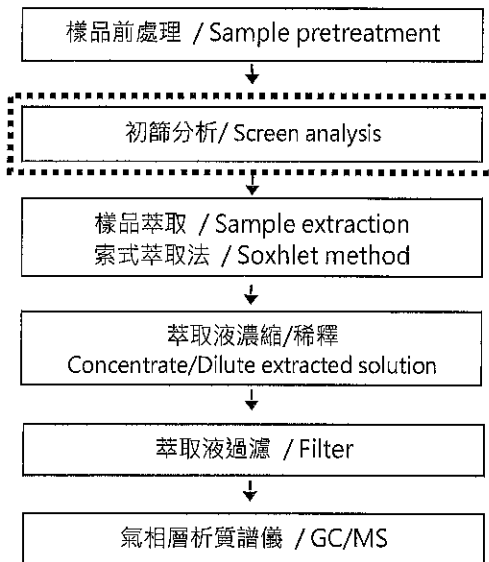
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### 多溴聯苯/多溴聯苯醌分析流程圖 / Analytical flow chart - PBBs/PBDEs

- 初次測試程序 / First testing process      —————→
- 選擇性篩檢程序 / Optional screen process      ······→
- 確認程序 / Confirmation process      - - - - -→



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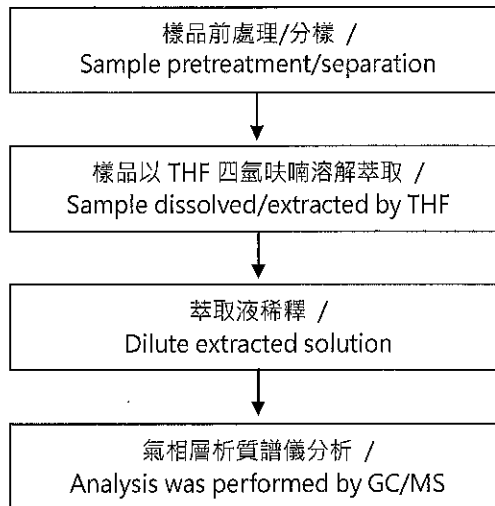
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## 可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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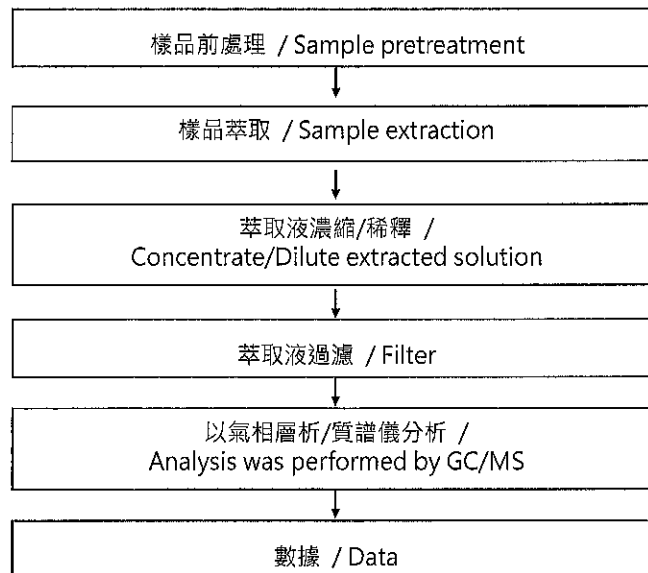
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### 六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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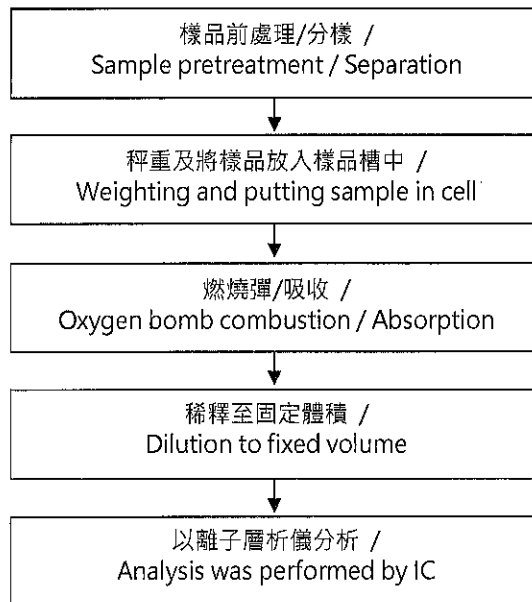
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### 鹵素分析流程圖 / Analytical flow chart - Halogen



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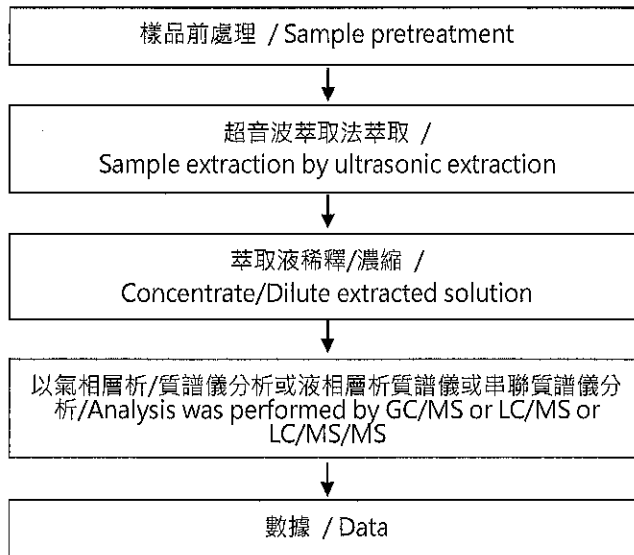
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### 全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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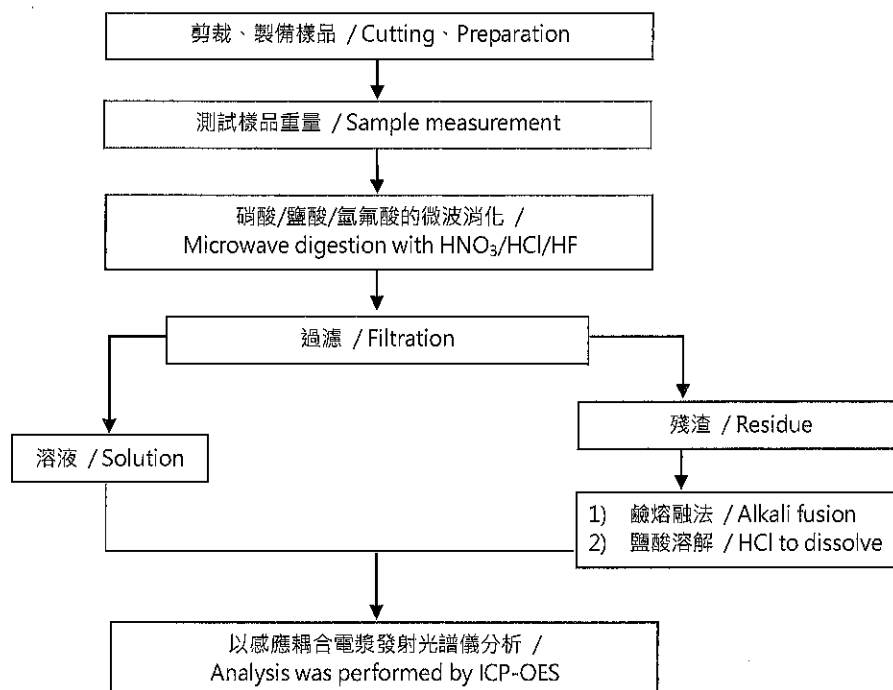
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## 元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件·樣品已完全溶解·

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method : US EPA 3051A · US EPA 3052】



\* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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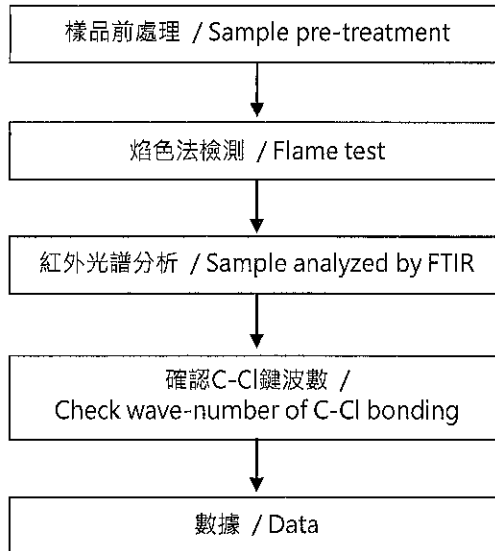
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## 聚氯乙炔物質判定分析流程圖 / Analysis flow chart - PVC



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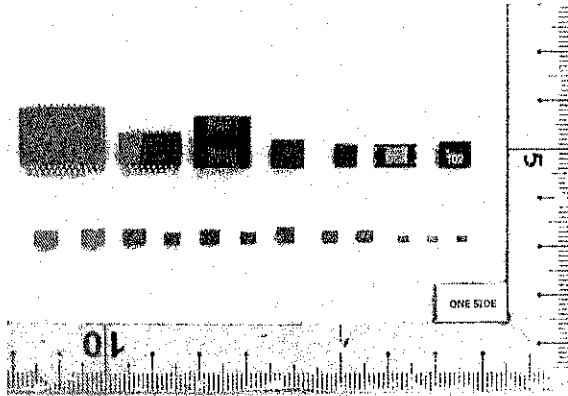
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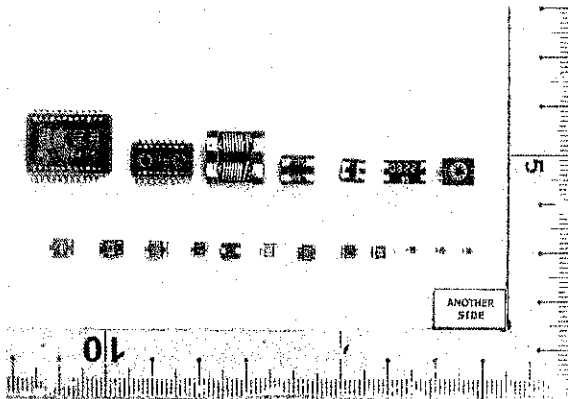
\* 照片中如有箭頭標示，則表示為實際檢測之樣品/部位。\*

(The tested sample / part is marked by an arrow if it's shown on the photo.)

## ETR23302694



## ETR23302694



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